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REFERE	NCE	DESIGNATION	U.S. P	ATEN	T DOCUMENTS					
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RD	1/	20020030720	March 14, 2002	Ка	wamura et al.					
4	1B 4,683,481 J		July 28, 1987	Jo	hnson					
1	1C			Dr	ake et al.					
64	1D			Bra	andon et al.					
(XI)	1E	6,215,946	April 10, 2001	Sh	errer					
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	16									
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		DOCUMENT NUMBER	PUBLICATION DATE		N PATENT DOCUMENTAME OF PATENTEE OR APPLICANT	Pages/Columns/Lines Where Relevant Passages/Figures Appear	Check if Translatio			
120	1L EP 0 795 406		Sept 17 1997	Lexmark Int'l, Inc.			1			
	11	1								
	11	1								
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	1F	•								
	•	OTHER RE	FERENCES (includ	ling A	uthor, Title, Date, Pe	rtinent Pages, etc.)				
ga.	Hewlett-Packard, Co. Patent Application Serial No. 10/262,406, filed Sept. 30, 2002									
06		IR American Sc Liquid Surfac	American Society for Precision Engineering, Kaiji Sato et al., "Self-Alignment of Microports using Liquid Surface Tension-Examination of the Alignment Characteristics", 2000, pp. 345-348.							
ØC.		1S IMTEK- Insti "Capillary Fo	IMTEK- Institute for Microsystem Technology, Albert Ludwig University, Andreas Greiner et al., "Capillary Forces in Micro-Fluidic Sell-Assembly".							
FXA	MINE	B (A) AND		<u>—</u>	DATE CONSIDERE	= 9/2004				
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FORM PTO-1449  LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT  (Use several sheets if necessary)				100204589-1	10/626065	TION NO		
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	10					_		
	1P		1					
		OTHER REF	ERENCES (includir	ng Author, Title, Date, Pe	rtinent Pages, etc.)			
Ole	10	Emerson & Co Underfill.	uming, Technical Da	ta Sheet, AMICON E 1172 F	ast Flow-Snap Cure Capillary Flo	ow J		
RA	1R	GPD Global,	GPD Global, "Liquid Encapsulation Protects Electronic Components", March 20, 2001, pp. 1-5.					
000	15	L. Gopalakris 1998 IEEE.	hnan et al., "Encaps	ulant Materials for Flip-Chip	Attach", pp. 1291-1297, copyri	ght		
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FORM PTO-1449  LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT				ATTY. DOCKET NO. 100204589-1		APPLICATION NO. CONFIRM	MATION	NO	
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